



Advance Information 8K x 8 Bit Static Random Access Memory

ELECTRICALLY TESTED PER:
MPG6264C

The 6264C is a 65,536-bit static random access memory organized as 8192 words of 8 bits, fabricated using Motorola's second-generation high-performance silicon-gate CMOS technology. Static design eliminates the need for external clocks or timing strobes, while CMOS circuitry reduces power consumption and provides for greater reliability.

The chip enable pins (E1 and E2) are not clocks. Either pin, when asserted false, causes the part to enter a low-power standby mode. The part will remain in standby mode until both pins are asserted true again. The availability of active high and active low chip enable pins provides more system design flexibility than single chip enable devices.

The 6264C is available in a 600 mil, 28-pin ceramic DIL, and a 32-terminal ceramic LCCC package and features the standard JEDEC pinout.

- Single 5.0 V ± 10% Power Supply
- Output Enable (G) Feature for Increased System Flexibility and to Eliminate Bus Contention Problems
- 8K x 8 Organization
- Fully Static — No Clock or Timing Strobes Necessary
- Fast Access Time — 15, 20, 25, 35, 45, 55, 70 ns
- Low Power Dissipation — 825 mW
- Fully TTL Compatible
- Three State Data Outputs

6264C

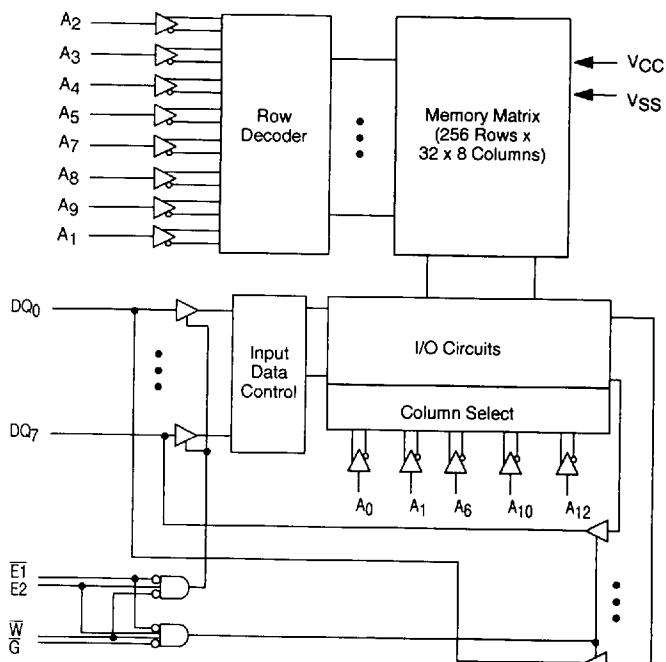
**Commercial Plus
and
Mil/Aero Applications**

AVAILABLE AS

- 1) JAN: N/A
 - 2) SMD: Pending
 - 3) 883: 6264C - XX/BXAJC
- X = CASE OUTLINE AS FOLLOWS:
PACKAGE: DIL: X
LCC: U
XX = Speed in ns
(15, 20, 25, 35, 45, 55, 70)

The letter "M" appears after the speed on LCC

BLOCK DIAGRAM



This document contains information on a new product. Specifications and information herein are subject to change without notice.

BURN-IN CONDITIONS:							
$V_{CC} = 5.0 \text{ V(min)}/6.0 \text{ V(max)}$, $R_1 = 39.2 \text{ k}\Omega \pm 20\%$, $C_1 = 0.1 \mu\text{F} \pm 20\%$,							
$V_H = 3.0 \text{ V(min)}/5.0 \text{ V(max)}$, $V_L = -0.5 \text{ V(min)}/0.0 \text{ V(max)}$,							
CP1: 100 kHz CP6: 3.125 kHz CP11: 97.66 Hz CP16: 3.052 Hz							
CP2: 50 kHz CP7: 1.563 kHz CP12: 48.83 Hz CP17: 1.526 Hz							
CP3: 25 kHz CP8: 0.781 kHz CP13: 24.41 Hz CP18: 0.763 Hz							
CP4: 12.5 kHz CP9: 0.391 kHz CP14: 12.21 Hz CP19: 0.382 Hz							
CP5: 6.25 kHz CP10: 0.195 kHz CP15: 6.104 Hz CP20: 0.191 Hz							

PIN NAME and FUNCTIONS

A ₀ – A ₁₂	Address Inputs
W	Write Enable
E ₁ , E ₂	Chip Enable
G	Output Enable
DQ ₀ – DQ ₇	Data Input/Output
V _{CC}	+5.0 V Power Supply
V _{SS}	Ground
N.C.	No Connection

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltages higher than maximum rated voltages to this high-impedance circuit.

TRUTH TABLE

E ₁	E ₂	G	W	Mode	Supply Current	I/O Pin
H	X	X	X	Not Selected	I _{SB}	High Z
X	L	X	X	Not Selected	I _{SB}	High Z
L	H	H	H	Output Disabled	I _{CC}	High Z
L	H	L	H	Read	I _{CC}	D _{OUT}
L	H	X	L	Write	I _{CC}	D _{IN}

X = Don't Care

ABSOLUTE MAXIMUM RATINGS (See Note)

Rating	Symbol	Value	Unit
Power Supply Voltage	V _{CC}	-0.5 to +7.0	V
Voltage Relative to V _{SS} for Any Pin Except V _{CC}	V _{IN} , V _{OUT}	-0.5 to V _{CC} + 0.5	V
Output Current (per I/O)	I _{OUT}	±20	mA
Power Dissipation (T _A = 25°C)	P _D	1.0	W
Temperature Under Bias	T _{bias}	-55 to +125	°C
Storage Temperature Range	T _{stg}	-65 to +150	°C
Operating Temperature Range	T _A	-55 to +125	°C

NOTE: Permanent device damage may occur if ABSOLUTE MAXIMUM RATINGS are exceeded. Functional operation should be restricted to RECOMMENDED OPERATING CONDITIONS. Exposure to higher than recommended voltages for extended periods of time could affect device reliability.

MOTOROLA SC MEMORY/ASI 65E D

COMMERCIAL PLUS AND MIL/AERO APPLICATIONS MEMORY DATA

DC OPERATING CONDITIONS AND CHARACTERISTICS
 (V_{CC} = 5.0 V ±10%, T_A = -55°C to +125°C, Unless Otherwise Noted)

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min	Max	Unit
Supply Voltage (Operating Voltage Range)	V _{CC}	4.5	5.5	V
Input High Voltage	V _{IH}	2.2	V _{CC} + 0.3	V
Input Low Voltage	V _{IL}	-0.3 *	0.8	V

* V_{IL} (min) = -0.5 Vdc; V_{IL} (min) = -3.0 Vdc (pulse width ≤ 20 ns)

DC CHARACTERISTICS

Parameter	Symbol	Min	Max	Unit
Input Leakage Current (All Inputs, V _{IN} = 0 to V _{CC})	I _{IL}	—	2.0	µA
Output Leakage Current (E ₁ = V _{IH} , E ₂ = V _{IL} , V _{OUT} = 0 to V _{CC})	I _{OZL}	—	2.0	µA
Operating Supply Current Cycle = Min, Duty = 100% +25, +125°C (15) -55°C (25)	I _{CCA} I _{CCA}	— —	150 135	mA mA
TTL Standby Current (E ₁ = V _{IH} , or E ₂ = V _{IL})	I _{SB1}	—	35	mA
CMOS Standby Current (E ₁ ≥ V _{CC} - 2.0 V, E ₂ ≥ 0.2 V)	I _{SB2}	—	20	mA
Output Low Voltage (I _{OL} = 8.0 mA)	V _{OL}	—	0.4	V
Output High Voltage (I _{OH} = -4.0 mA)	V _{OH}	2.4	—	V

CAPACITANCE (f = 1.0 MHz, T_A = 25°C, Sampled at initial device qualification and major redesign rather than 100% tested)

Characteristic	Symbol	Min	Typ	Max	Unit
Input Capacitance All Inputs Except DQ	C _{in}	—	5.0	10	pF
I/O Capacitance DQ	C _{I/O}	—	6.0	12	pF

AC OPERATING CONDITIONS AND CHARACTERISTICS
 (V_{CC} = 5.0 V ± 10%, T_A = -55°C to +125°C, Unless Otherwise Noted)

Input Reference Level	1.5 V
Input Pulse levels	0 to 3.0 V
Input Rise/Falls Time	5.0 ns
Output Reference Level	1.5 V
Output Load	See Figure 1

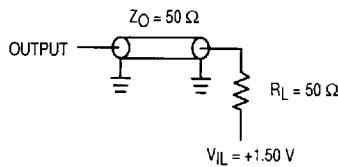


Figure 1A.

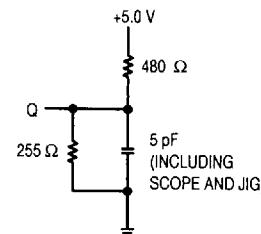


Figure 1B.

MOTOROLA SC {MEMORY/ASI 65E }

WRITE CYCLE 1 (W Controlled, See Note 1)

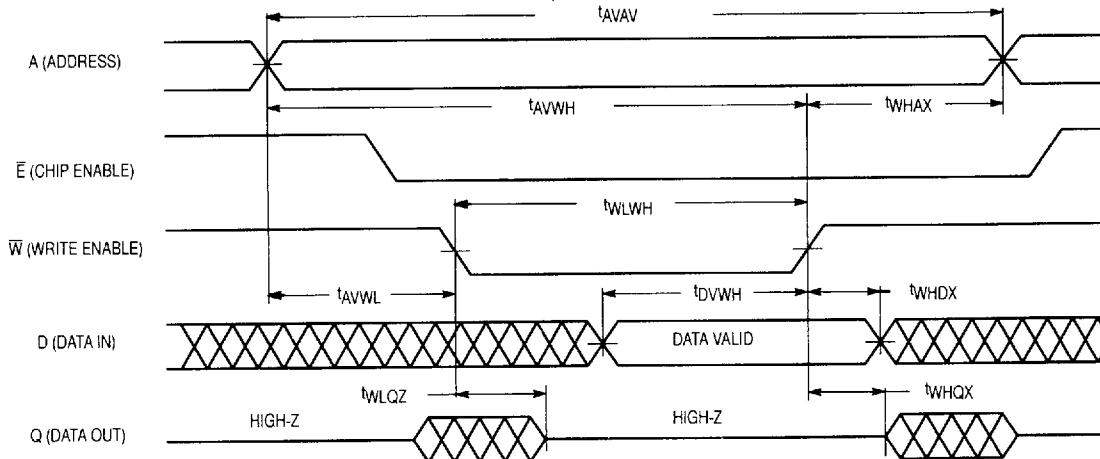
Parameter	Symbol Standard	Symbol Alternate	6264C-15		6264C-20		6264C-25		6264C-35		Unit	Notes
			Min	Max	Min	Max	Min	Max	Min	Max		
Write Cycle Time	tAVAV	tWC	15	—	20	—	25	—	35	—	ns	—
Address Setup Time	tAVWL	tAS	0	—	0	—	0	—	0	—	ns	—
Address Valid to End of Write	tAVWH	tAW	10	—	15	—	20	—	30	—	ns	—
Write Pulse Width	tWLWH	tWP	10	—	15	—	20	—	30	—	ns	2
Data Valid to End of Write	tDVWH	tDW	5.0	—	10	—	15	—	25	—	ns	—
Data Hold Time	tWHDX	tDH	0	—	0	—	0	—	0	—	ns	3
Write High to Output Low-Z	tWHQX	tWLZ	0	—	0	—	0	—	0	—	ns	4

WRITE CYCLE 1 (W Controlled, See Note 1)

Parameter	Symbol Standard	Symbol Alternate	6264C-45		6264C-55		6264C-70		Unit	Notes
			Min	Max	Min	Max	Min	Max		
Write Cycle Time	tAVAV	tWC	45	—	55	—	70	—	ns	—
Address Setup Time	tAVWL	tAS	0	—	0	—	0	—	ns	—
Address Valid to End of Write	tAVWH	tAW	40	—	50	—	65	—	ns	—
Write Pulse Width	tWLWH	tWP	40	—	50	—	65	—	ns	2
Data Valid to End of Write	tDVWH	tDW	35	—	45	—	60	—	ns	—
Data Hold Time	tWHDX	tDH	0	—	0	—	0	—	ns	3
Write High to Output Low-Z	tWHQX	tWLZ	0	—	0	—	0	—	ns	4

NOTES:

1. A write cycle starts at the latest transition of a low $\bar{E}1$, or low \bar{W} or high $E2$. A write cycle ends at the earliest transition of a high $E1$, high W or low $E2$.
2. If W goes low coincident with or prior to $\bar{E}1$ low or $E2$ high then the outputs will remain in a high impedance state.
3. During this time the output pins may be in the output state. Signals of opposite phase to the outputs must not be applied at this time.
4. All high-Z AND low-Z parameters are considered in a high or low impedance state when the output has made a 500 mW transition from the previous steady state voltage.

WRITE CYCLE 1 (W Controlled)**TIMING LIMITS**

The table of timing values shows either a minimum or a maximum limit for each parameter. Input requirements are specified from the external system point of view. Thus, address setup time is shown as a minimum since the system must supply at least that much time (even though most devices do not require it). On the other hand, responses from the memory are specified from the device point of view. Thus, the access time is shown as a maximum since the device never provides data later than that time.

WRITE CYCLE 2 (See Note 1)

Parameter	Symbol Standard	Symbol Alternate	6264C-15		6264C-20		6264C-25		6264C-35		Unit	Notes
			Min	Max	Min	Max	Min	Max	Min	Max		
Write Cycle Time	tAVAV	tWC	15	—	20	—	25	—	35	—	ns	—
Address Setup Time	tAVEL	tAS	0	—	0	—	0	—	0	—	ns	—

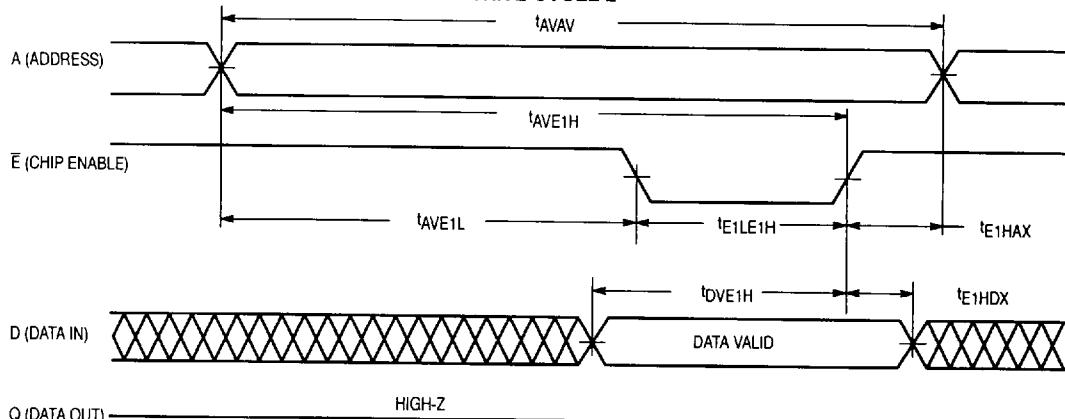
WRITE CYCLE 2 (See Note 1)

Parameter	Symbol Standard	Symbol Alternate	6264C-45		6264C-55		6264C-70		Unit	Notes
			Min	Max	Min	Max	Min	Max		
Write Cycle Time	tAVAV	tWC	45	—	55	—	70	—	ns	—
Address Setup Time	tAVEL	tAS	0	—	0	—	0	—	ns	—

NOTES:

1. A write cycle starts at the latest transition of a low E1, or low W or high E2. A write cycle ends at the earliest transition of a high E1, high W or low E2.
2. E1 and E2 timing are identical when E2 signals are inverted.

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WRITE CYCLE 2**READ CYCLE** (See Note 1)

Parameter	Symbol Standard	Symbol Alternate	6264C-15		6264C-20		6264C-25		6264C-35		Unit	Notes
			Min	Max	Min	Max	Min	Max	Min	Max		
Read Cycle Time	tAVAV	tRC	15	—	20	—	25	—	35	—	ns	—
Address Access Time	tAVQV	tAA	—	15	—	20	—	25	—	35	ns	—
E1 Access Time	tE1LQV	tAC1	—	15	—	20	—	25	—	35	ns	—
E2 Access Time	tE2HQV	tAC2	—	15	—	20	—	25	—	35	ns	—
G Access Time	tGLQV	tOE	—	12	—	15	—	20	—	25	ns	—
Chip Enable to Output Low-Z	tE1LQZ, tE2HQZ	tCLZ	5.0	—	5.0	—	5.0	—	5.0	—	ns	2
Output Enable to Output Low-Z	tGLQZ	tOLZ	0	—	0	—	0	—	0	—	ns	2
Chip Enable to Output High-Z	tE1HQZ, tE2LQZ	tCHZ	—	5.0	—	10	—	15	—	20	ns	2, 3
Output Enable to Output High-Z	tGHQZ	tOHZ	—	5.0	—	10	—	15	—	20	ns	2, 3

NOTES:

1. W is high at all times for read cycles.
2. All high-Z and low-Z parameters are considered in a high or low impedance state when the output has made a 500 mV transition from the previous steady state voltage.
3. This parameter is sampled and not 100% tested.

READ CYCLE (See Note 1)

Parameter	Symbol Standard	Symbol Alternate	6264C-45		6264C-55		6264C-70		Unit	Notes
			Min	Max	Min	Max	Min	Max		
Read Cycle Time	t _{AVAV}	t _{RC}	45	—	55	—	70	—	ns	—
Address Access Time	t _{AVQV}	t _{AA}	—	45	—	55	—	70	ns	—
\bar{E}_1 Access Time	t _{E1LQV}	t _{AC1}	—	45	—	55	—	70	ns	—
E ₂ Access Time	t _{E2HQV}	t _{AC2}	—	45	—	55	—	70	ns	—
\bar{G} Access Time	t _{GLQV}	t _{OE}	—	30	—	35	—	40	ns	—
Chip Enable to Output Low-Z	t _{E1LQX} , t _{E2HQX}	t _{CLZ}	5.0	—	5.0	—	5.0	—	ns	2
Output Enable to Output Low-Z	t _{GLQX}	t _{OLZ}	0	—	0	—	0	—	ns	2
Chip Enable to Output High-Z	t _{E1HQZ} , t _{E2LQZ}	t _{CHZ}	—	25	—	30	—	35	ns	2, 3
Output Enable to Output High-Z	t _{GHQZ}	t _{OHZ}	—	25	—	30	—	35	ns	2, 3

NOTES:

1. W is high at all times for read cycles.
2. All high-Z and low-Z parameters are considered in a high or low impedance state when the output has made a 500 mV transition from the previous steady state voltage.
3. This parameter is sampled and not 100% tested.

READ CYCLE
MOTOROLA SC MEMORY/ASI 65E D

